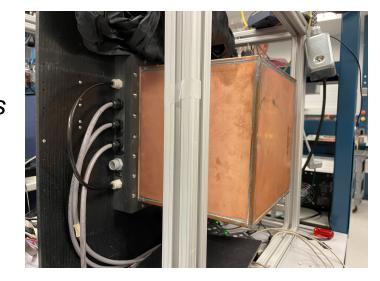
Plan C is now the default

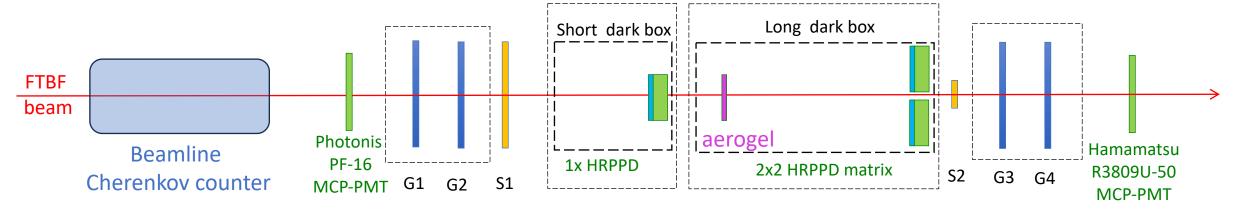
- > De-couple the vessel / mirror PED effort and the May 2024 beam test entirely
 - Implies using existing custom dark box(es)
 - Vessel / mirror work can then be comfortably concluded in summer 2024
- ➤ Give up porting pfRICH software to dd4hep for the beam test purposes
- > Two weeks of running
 - First week: 120 GeV primary beam, setting up, ORC, timing, saturated rings
 - \triangleright Second week: π/K separation at low energy



Fermilab news:

- "Internal Readiness Review (IRR) for Accelerator Safety covering the areas of Booster, MI-8 line, BNB, Main Injector / Recycler and NuMI successfully completed"
- Yet comments need to be addressed, then a sign off is needed to turn on
- > FTBF review happened yesterday

Plan C: test setup @ Fermilab



- > Main deliverable is a direct simultaneous demonstration of
 - \triangleright π/K separation at ~7 GeV/c via imaging, with and without an acrylic filter
 - > HRPPD performance as a t₀ reference sensor for ePIC ToF subsystems
 - <50 ps timing resolution using aerogel Cherenkov photons</p>
 - O(20ps) timing resolution using Cherenkov photon flashes in HRPPD window

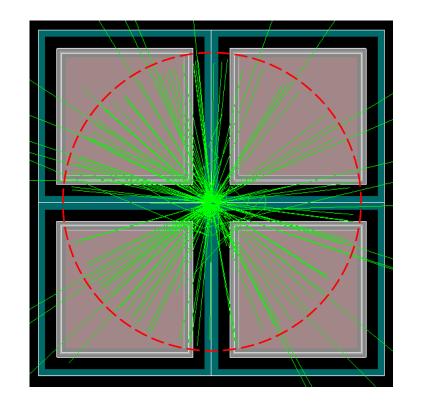
Optional

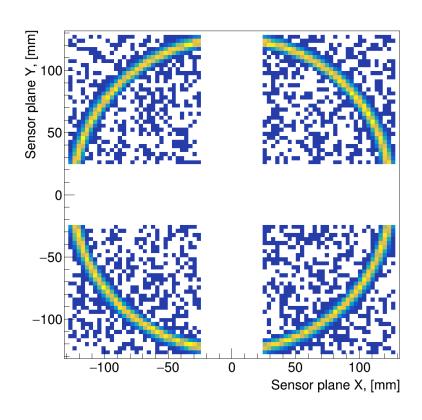
- First mirror pieces (perhaps small flat funneling ones?)
- Dual aerogel configuration?

Aerogel Specifications To: JLab	Dated December 8, 2023 Manufactured and measured by M. Tabata
Туре	TSA1.04 TSA1.04 TSA1.04

Туре	TSA1.04	TSA1.04	TSA1.04
Serial number	TSA114-3	TSA120-1	TSA120-2
Refractive index (at 405 nm)	1.0377	1.0404	1.0401
Transmission length (at 400 nm) [mm]	51.2	48.9	49.3
Transmittance (at 400 nm) [%]	61.2	60.6	60.5
Lateral tile size (nominal) [mm]	109.9	109.4	110.4
Thickness (nominal) [mm]	25.1	24.5	24.8
Weight [g]	42.79	42.21	43.12
Density [g/cm ³]	0.141	0.144	0.143
Appearance	Slight damages	Good	Good
File name of transmittance data [.txt]	tsa114-3_ 2023.12	tsa120-1	tsa120-2

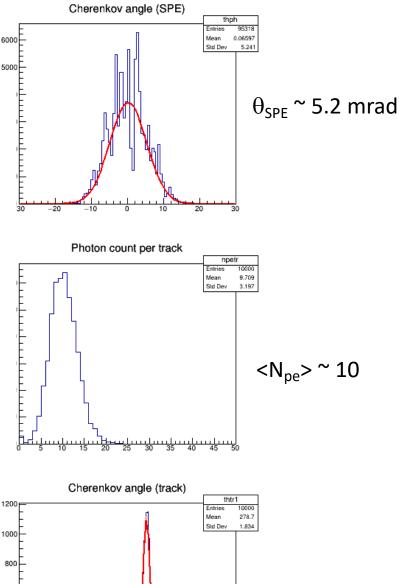
Plan C: expected performance

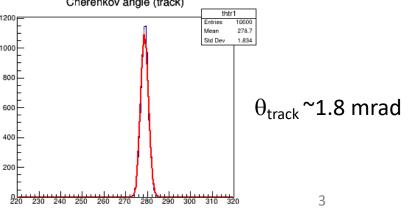






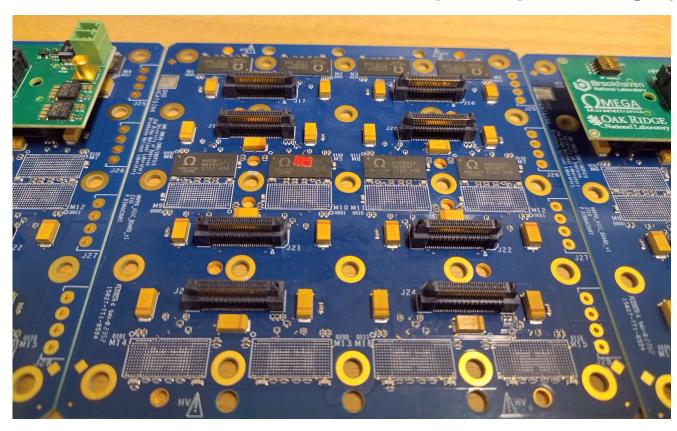
- > <N_{pe}> ~ 10, assuming that HRPPD PDE is 0.7 (our safety factor)
- ➤ Track-level Cherenkov angle resolution ~1.8 mrad
 - \triangleright Compare to ~7.5 mrad π /K separation at 7 GeV/c for <n> ~ 1.04

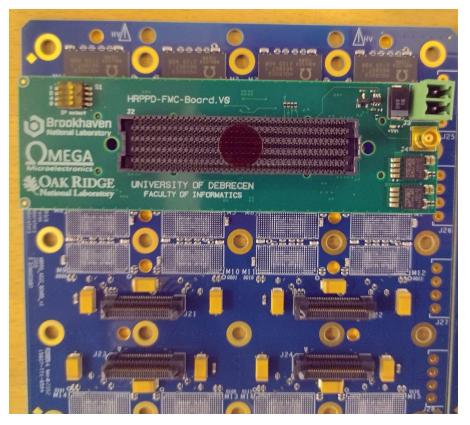




HGCROC3 ASIC / FPGA backplane

IN2P3 [OMEGA] (Pierrick, Damien), Uni Debrecen (Gabor, Miklos)
BNL (Daniel), Oak Ridge (Norbert)





- > Four partly assembled ASIC boards are produced and shipped to Debrecen and BNL
- > ASIC board + FMC (passive) board + KCU105 FPGA kit debugging @ Debrecen will take ~two weeks
- > FPGA bare board production is delayed substantially; expected by March 1st